

Call for Papers

tinyML Research Symposium 2021

Monday, March 22, 2021

OpenReview

New academic & commercial research symposium as part of the tinyML Summit 2021

Program Chairs

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Important Deadlines

Date: Nov 23 2020 11:59pm AOE
New Date: Nov 30 2020 11:59pm

AOE

Author Notification: Feb 5 Jan 15.

2021

Camera Ready: Feb 15, 2021

Submission Page Limit

6 - 8 pages, including references. Submissions must be blind (i.e., no author information allowed)

Submission Website

Tiny machine learning (tinyML) is a fast-growing field of machine learning technologies and applications including algorithms, hardware, and software capable of performing on-device sensor (vision, audio, IMU, biomedical, etc.) data analytics at extremely low power, typically in the mW range and below, and hence enabling a variety of always-on use-cases and targeting battery-operated devices. tinyML systems are becoming "good enough" for (i) many commercial applications and new systems on the horizon; (ii) significant progress is being made on algorithms, networks, and models down to 100 kB and below; and (iii) initial low power applications in vision and audio are becoming mainstream and commercially available. There is growing momentum demonstrated by technical progress and ecosystem development. The first annual tinyML research symposium serves as a flagship venue for research at the intersection of machine learning applications, algorithms, software, and hardware in deeply embedded machine learning systems. We solicit papers from academia and industry combining cross-layer innovations across two or more topics. Submissions must describe tinyML innovations that intersect and leverage synergy between at least two of the following subject areas:

tinyML Datasets

- Public release of new datasets to tinyML
- Frameworks that automate dataset development
- Survey and analysis of existing tiny datasets that can be used for research

tinyML Applications

- Novel applications across all fields and emerging use cases
- Discussions about real-world use cases
- User behavior and system-user interaction
- Survey on practical experiences

tinyML Algorithms

- Federated learning or stream-based active learning methods
- Deep learning and traditional machine learning algorithms
- Pruning, quantization, optimization methods
- Security and privacy implications

tinyML Systems

- Profiling tools for measuring and characterizing performance and power
- Solutions that involve hardware and software co-design
- Characterization of tiny real-world embedded systems
- In-sensor processing, design, and implementation

tinyML Software

- Interpreters and code generator frameworks for tiny systems
- Optimizations for efficient execution
- Software memory optimizations
- Neural architecture search methods

tinyML Hardware

- Power management, reliability, security, performance
- Circuit and architecture design
- Ultra-low-power memory system design
- MCU and accelerator architecture design and evaluation

tinyML Evaluation

- Measurement tools and techniques
- Benchmark creation, assessment and validation
- Evaluation and measurement of real production systems

All submitted papers must be anonymized; no author information. The review process is double-blind. Accepted papers will be published as peer-reviewed online proceedings. An author of an accepted paper must attend the symposium to give a presentation.

Accepted full papers will be invited to submit an extended manuscript to a "Title:



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Paper
Template: ACM
(SIGCONF)

 $\label{eq:computing_special} \begin{tabular}{ll} TinyML" & Special Issue in ACM Transactions on Embedded Computing Systems (TECS). \end{tabular}$